



## 600 Watt Surface Mount Transient Voltage Suppressor

Screening in  
reference to  
**MIL-PRF-19500**  
available

### DESCRIPTION

The MSMB 5.0A – MSMB 170CA series of surface mount 600 watt transient voltage suppressors provide a selection of standoff voltages (V<sub>wm</sub>) from 5.0 to 170 V. These high-reliability devices are available in either unidirectional or bidirectional versions. The SMBG Gull-wing design in the DO-215AA package is ideal for visible solder connections. The SMBJ J-bend design in the DO-214AA package allows for greater PC board mounting density. It is available with SnPb or RoHS compliant matte-tin plating.

**Important:** For the latest information, visit our website <http://www.microsemi.com>.

### FEATURES

- High reliability devices with wafer fabrication and assembly lot traceability.
- All devices 100% surge tested.
- Enhanced reliability screening in reference to MIL-PRF-19500 is also available. Refer to [High Reliability Up-Screened Plastic Products Portfolio](#) for more details on the screening options.  
(See [part nomenclature](#) for all options.)
- Moisture classification is Level 1 with no dry pack required per IPC/JEDEC J-STD-020B.
- 3σ lot norm screening performed on standby current (I<sub>D</sub>).
- RoHS compliant versions available.

### APPLICATIONS / BENEFITS

- Protects sensitive components such as IC's, CMOS, Bipolar, BiCMOS, ECL, DTL, T2L, etc.
- Protection from switching transients & RF induced voltage pulses.
- Protection from ESD and EFT per IEC 61000-4-2 and IEC 61000-4-4.
- Secondary lightning protection per IEC61000-4-5 with 42 ohms source impedance:
  - Class 1: MSB 5.0A to MSMB 120CA
  - Class 2: MSMB 5.0A to MSMB 60CA
  - Class 3: MSMB 5.0A to MSMB 30CA
  - Class 4: MSMB 5.0A to MSMB 15CA
- Secondary lightning protection per IEC61000-4-5 with 12 ohms source impedance:
  - Class 1: MSMB 5.0A to MSMB 36CA
  - Class 2: MSMB 5.0A to MSMB 18CA

### MAXIMUM RATINGS @ 25 °C unless otherwise stated

Parameters/Test Conditions	Symbol	Value	Unit
Junction and Storage Temperature	T <sub>J</sub> and T <sub>STG</sub>	-65 to +150	°C
Thermal Resistance, Junction to Lead	R <sub>θJL</sub>	25	°C/W
Thermal Resistance, Junction to Ambient <sup>(1)</sup>	R <sub>θJA</sub>	90	°C/W
Peak Pulse Power Dissipation <sup>(2)</sup>	P <sub>PP</sub>	600	W
Rated Average Power Dissipation <sup>(1)</sup>	P <sub>M(AV)</sub>	5 1.38	W
T <sub>clamping</sub> (0 volts to V <sub>(BR)</sub> min)	Unidirectional Bidirectional	< 100 < 5	ps ns
Forward Surge Current <sup>(3)</sup>	I <sub>FS</sub>	100	A (pk)
Solder Temperature @ 10 s	T <sub>SP</sub>	260	°C

- Notes:**
1. When mounted on FR4 PC board (1oz Cu) with recommended footprint (see [pad layout](#) on last page).
  2. With impulse repetition rate (duty factor) of 0.01 % or less (also [Figure 1 and 4](#)).
  3. Peak impulse of 8.3 ms half-sine wave (unidirectional only).



**DO-215AA**  
**Gull-wing Package**



**DO-214AA**  
**J-bend Package**

NOTE: All SMB series are equivalent to prior SMS package identifications.

Also available in:

**Commercial Grade**  
[SMBJ5.0A – SMBJ170CAe3](#)

**T-18 package**  
(axial-leaded)  
[P6KE6.8A – P6KE200CAe3](#)

### MSC – Lawrence

6 Lake Street,  
Lawrence, MA 01841  
Tel: 1-800-446-1158 or  
(978) 620-2600  
Fax: (978) 689-0803

### MSC – Ireland

Gort Road Business Park,  
Ennis, Co. Clare, Ireland  
Tel: +353 (0) 65 6840044  
Fax: +353 (0) 65 6822298

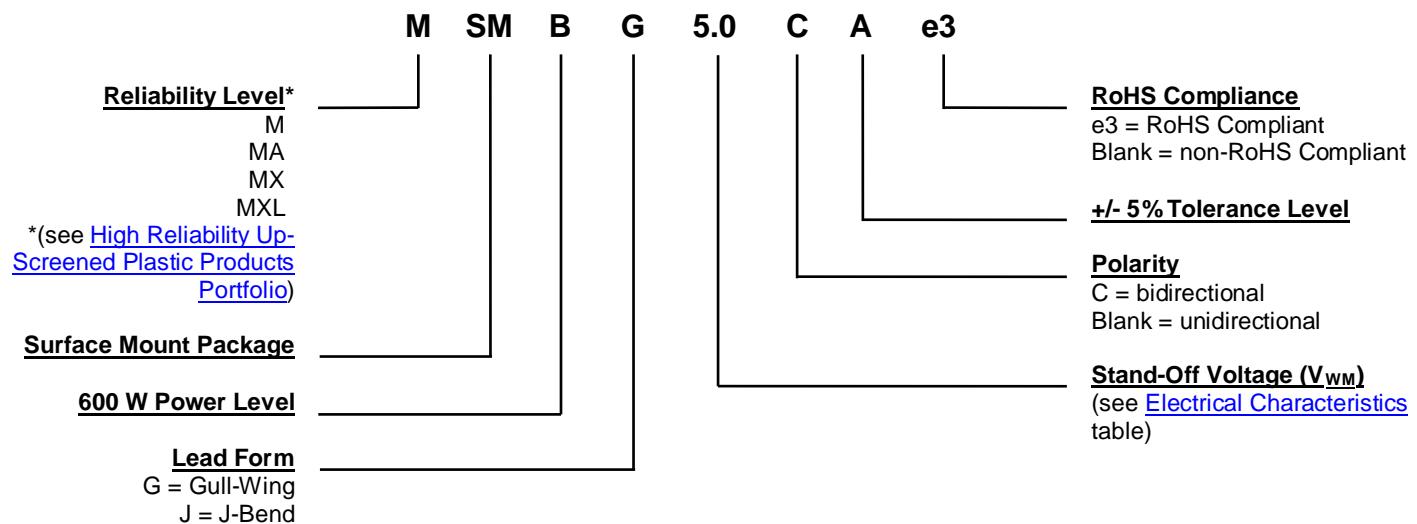
### Website:

[www.microsemi.com](http://www.microsemi.com)

### MECHANICAL and PACKAGING

- CASE: Void-free transfer molded thermosetting epoxy body meeting UL94V-0 requirements.
- TERMINALS: Tin-lead or RoHS compliant annealed matte-tin plating readily solderable per MIL- STD-750, method 2026.
- MARKING: Part number.
- POLARITY: Cathode end banded.
- TAPE & REEL option: Standard per EIA-481-1-A (add “TR” suffix to part number). Consult factory for quantities.
- WEIGHT: Approximately 0.1 grams.
- See [Package Dimensions](#) on last page.

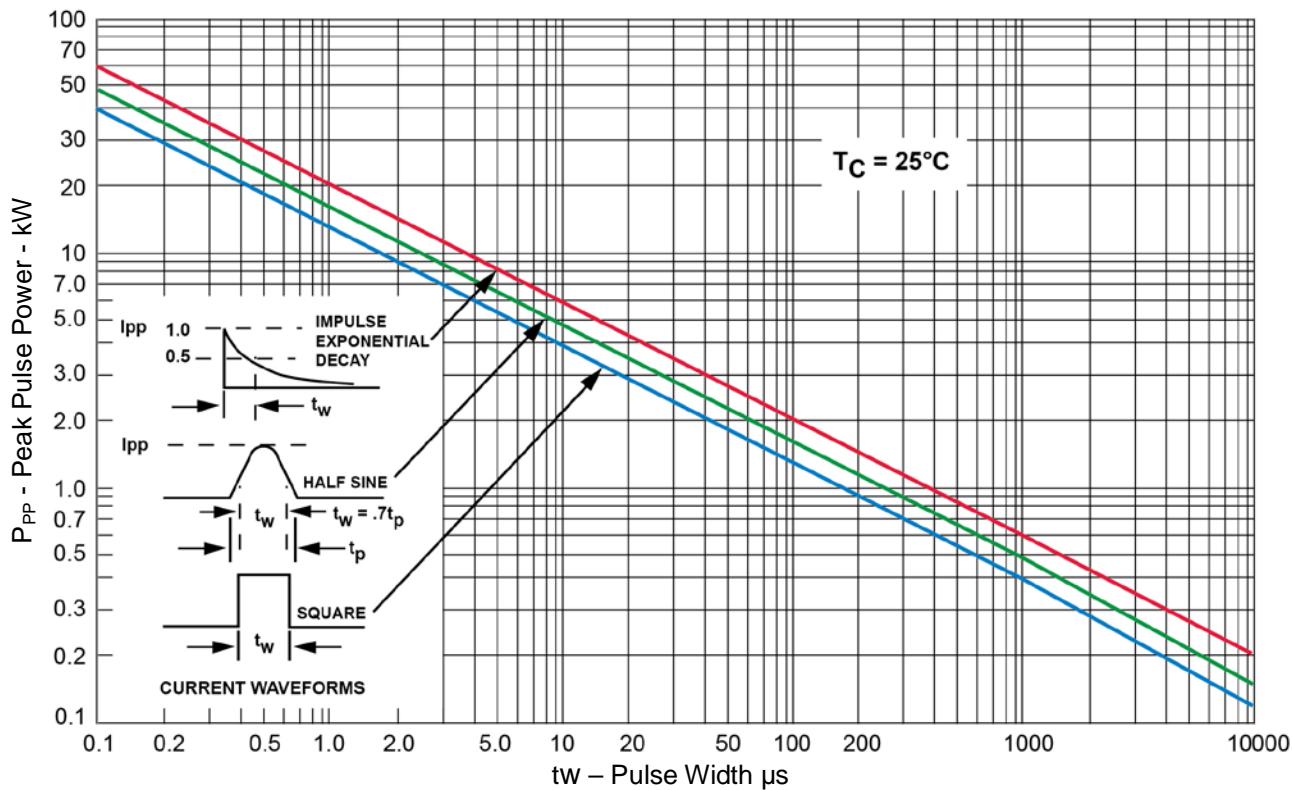
### PART NOMENCLATURE



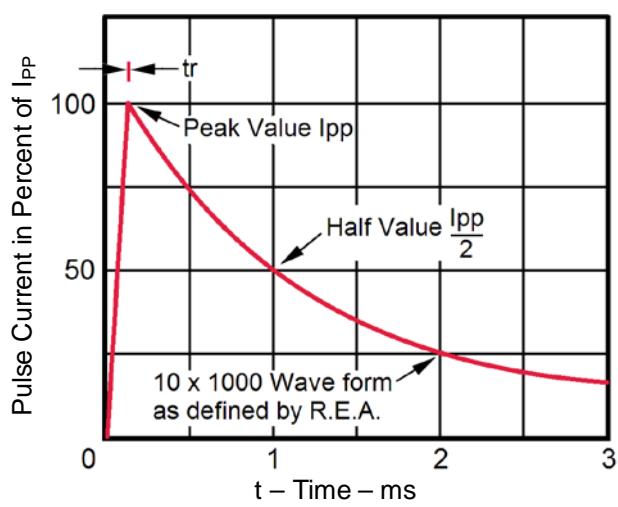
### SYMBOLS & DEFINITIONS

Symbol	Definition
$V_{WM}$	Working Peak (Standoff) Voltage - The maximum peak voltage that can be applied over the operating temperature range. This is also referred to as standoff voltage.
$P_{PP}$	Peak Pulse Power - Rated random recurring peak impulse power dissipation.
$V_{(BR)}$	Breakdown Voltage - The minimum voltage the device will exhibit at a specified current.
$I_D$	Standby Current - The current at the rated standoff voltage ( $V_{WM}$ ).
$I_{PP}$	Peak Pulse Current - The peak current during the impulse.
$V_C$	Clamping Voltage - Clamping voltage at $I_{PP}$ (peak pulse current) at the specified pulse conditions (typically shown as maximum value).
$I_{BR}$	Breakdown Current – The current used for measuring breakdown voltage $V_{(BR)}$ .

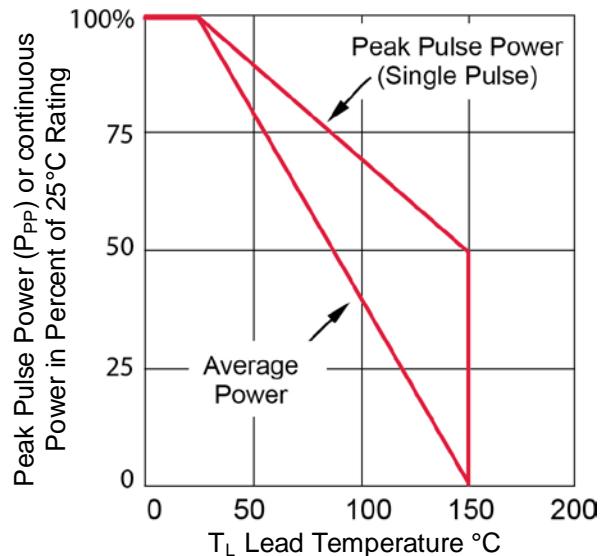


**GRAPHS**


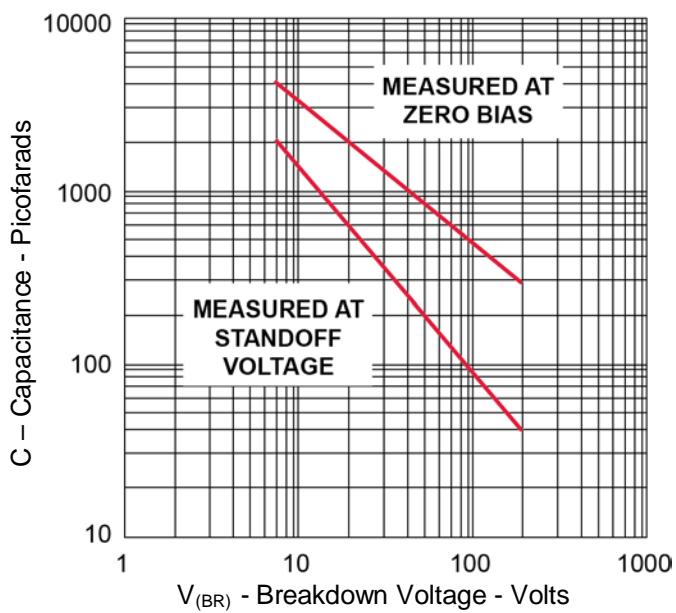
**FIGURE 1**  
Peak Pulse Power vs Pulse Time



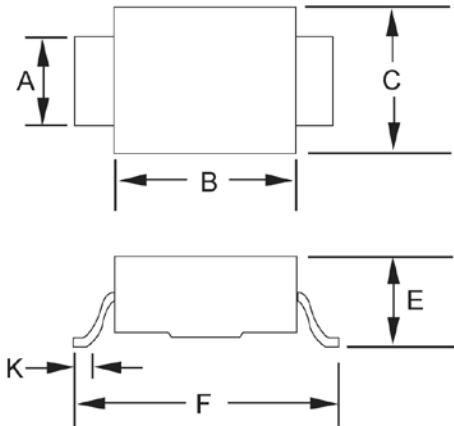
**FIGURE 2**  
Pulse Waveform for 10/1000 Exponential Surge

**GRAPHS (continued)**


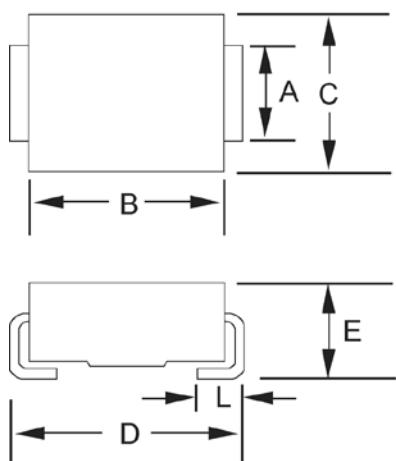
**FIGURE 3**  
Derating Curve



**FIGURE 4**  
Typical Capacitance vs. Breakdown Voltage  
 NOTE: Bidirectional capacitance is half that shown at zero volts.

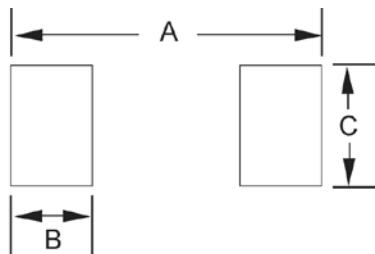
**PACKAGE DIMENSIONS**

**SMBG (DO-215AA)**

Ltr	Dimensions			
	Inch		Millimeters	
	Min	Max	Min	Max
<b>A</b>	.077	.083	1.96	2.10
<b>B</b>	.160	.180	4.06	4.57
<b>C</b>	.130	.155	3.30	3.94
<b>E</b>	.077	.104	1.95	2.65
<b>F</b>	.235	.255	5.97	6.48
<b>K</b>	.015	.030	.381	.762


**SMBJ (DO-214AA)**

Ltr	Dimensions			
	Inch		Millimeters	
	Min	Max	Min	Max
<b>A</b>	.077	.083	1.96	2.10
<b>B</b>	.160	.180	4.06	4.57
<b>C</b>	.130	.155	3.30	3.94
<b>D</b>	.205	.220	5.21	5.59
<b>E</b>	.077	.104	1.95	2.65
<b>L</b>	.030	.060	.760	1.52

*See pad layout on next page.*

**PAD LAYOUT**

<b>SMBG (DO-215AA)</b>		
<b>Ltr</b>	<b>Inch</b>	<b>Millimeters</b>
<b>A</b>	0.320	8.13
<b>B</b>	0.085	2.16
<b>C</b>	0.110	2.79

<b>SMBJ (DO-214AA)</b>		
<b>Ltr</b>	<b>Inch</b>	<b>Millimeters</b>
<b>A</b>	0.260	6.60
<b>B</b>	0.085	2.16
<b>C</b>	0.110	2.79

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[MASMBG28Ae3](#) [MXLSMBJ28CA](#) [MSMBJ64CA](#) [MXSMBG58A](#) [MXSMBG24A](#) [MSMBJ36A](#) [MXSMBJ58A](#)  
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